onsemi

MOSFET – Power, N-Channel, SUPERFET III, Easy Drive

650 V, 44 A, 67 m Ω

FCH067N65S3

Description

SUPERFET III MOSFET is **onsemi**'s brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provides superior switching performance, and withstand extreme dv/dt rate.

Consequently, SUPERFET III MOSFET Easy drive series helps manage EMI issues and allows for easier design implementation.

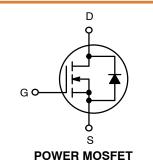
Features

- 700 V @ T_J = 150°C
- Typ. $R_{DS(on)} = 59 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. Q_g = 78 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 715 pF)
- 100% Avalanche Tested
- These Devices are Pb-Free and are RoHS Compliant

Applications

- Telecom / Server Power Supplies
- Industrial Power Supplies
- UPS / Solar

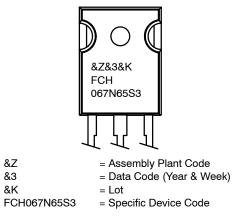
V _{DSS}	R _{DS(ON)} MAX	I _D MAX	
650 V	$67~\mathrm{m}\Omega @ 10~\mathrm{V}$	44 A	





TO-247 LONG LEADS CASE 340CH

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Parameter	FCH067N65S3-F155	Unit V	
V _{DSS}	Drain to Source Voltage			650
V _{GSS}	Gate to Source Voltage	– DC	±30	V
		– AC (f > 1 Hz)	±30	
ID	Drain Current	– Continuous (T _C = 25°C)	44*	А
		– Continuous (T _C = 100°C)	28*	
I _{DM}	Drain Current	– Pulsed (Note 1)	110*	А
E _{AS}	Single Pulsed Avalanche Energy (Note 2)	gle Pulsed Avalanche Energy (Note 2)		mJ
I _{AS}	Avalanche Current (Note 2)	8.8	А	
E _{AR}	Repetitive Avalanche Energy (Note 1)	Repetitive Avalanche Energy (Note 1)		mJ
dv/dt	MOSFET dv/dt Peak Diode Recovery dv/dt (Note 3)		100	V/ns
			20	
PD	Power Dissipation	(T _C = 25°C)	312	W
		- Derate Above 25°C	2.5	W/°C
T _J , T _{STG}	T _J , T _{STG} Operating and Storage Temperature Range		-55 to +150	°C
ΤL	Maximum Lead Temperature for Soldering, 1/8"	300	°C	

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, Unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. *Drain current limited by maximum junction temperature.

1. Repetitive rating: pulse width limited by maximum junction temperature. 2. $I_{AS} = 8.8 \text{ A}, R_G = 25 \Omega$, starting $T_J = 25^{\circ}C$.

3. $I_{SD} \le 22$ A, di/dt ≤ 200 A/µs, $V_{DD} \le 380$ V, starting $T_J = 25^{\circ}C$.

THERMAL CHARACTERISTICS

Symbol	Parameter	FCH067N65S3-F155	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.4	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient, Max.	40	

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Packing Method	Reel Size	Tape Width	Quantity
FCH067N65S3-F155	FCH067N65S3	TO-247 G03	Tube	N/A	N/A	30 Units



ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
OFF CHARACT	ERISTICS					
BV _{DSS}	Drain to Source Breakdown Voltage	V_{GS} = 0 V, I_D = 1 mA, T_J = 25°C	650	-	-	V
		V_{GS} = 0 V, I _D = 1 mA, T _J = 150°C	700	-	-	V
$\Delta \text{BV}_{\text{DSS}}$ / $\Delta \text{T}_{\text{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 1$ mA, Referenced to 25°C	-	0.72	-	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 650 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1	μA
		V_{DS} = 520 V, T_{C} = 125°C	-	2.2	-	
I _{GSS}	Gate to Body Leakage Current	V_{GS} = ±30 V, V_{DS} = 0 V	-	-	±100	nA
ON CHARACTE	RISTICS	-				
V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 1 \text{ mA}$	2.5	-	4.5	V
R _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 22 \text{ A}$	-	59	67	mΩ
9 _{FS}	Forward Transconductance	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 22 \text{ A}$	-	29	-	S
	RACTERISTICS					
C _{iss}	Input Capacitance	V_{DS} = 400 V, V_{GS} = 0 V, f = 1 MHz	-	3090	-	pF
Coss	Output Capacitance	1	-	68	-	pF
C _{oss(eff.)}	Effective Output Capacitance	V_{DS} = 0 V to 400 V, V_{GS} = 0 V	-	715	-	pF
C _{oss(er.)}	Energy Related Output Capacitance	V_{DS} = 0 V to 400 V, V_{GS} = 0 V	-	104	-	pF
Q _{g(tot)}	Total Gate Charge at 10 V	V _{DS} = 400 V, I _D = 22 A, V _{GS} = 10 V (Note 4)	-	78	-	nC
Q _{gs}	Gate to Source Gate Charge		-	18	-	nC
Q _{gd}	Gate to Drain "Miller" Charge		-	30	-	nC
ESR	Equivalent Series Resistance	f = 1 MHz	-	0.6	-	Ω
WITCHING CH	IARACTERISTICS					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 22 \text{ A}, \text{ V}_{GS} = 10 \text{ V},$	-	26	-	ns
t _r	Turn-On Rise Time	R _g = 4.7 Ω (Note 4)	_	52	-	ns
t _{d(off)}	Turn-Off Delay Time		_	89	-	ns
t _f	Turn-Off Fall Time	1	_	16	-	ns
OURCE-DRAII	N DIODE CHARACTERISTICS					
۱ _S	Maximum Continuous Source to Drain Diode Forward Current			-	44	Α
I _{SM}	Maximum Pulsed Source to Drain Diode Forward Current			-	110	Α
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_{SD} = 22 A$	-	-	1.2	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 V, I_{SD} = 22 A,$	-	435	-	ns
Q _{rr}	Reverse Recovery Charge	dI _F /dt = 100 A/μs	_	9.2	-	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
4. Essentially independent of operating temperature typical characteristics.



TYPICAL PERFORMANCE CHARACTERISTICS

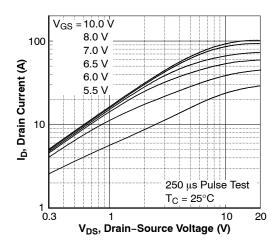
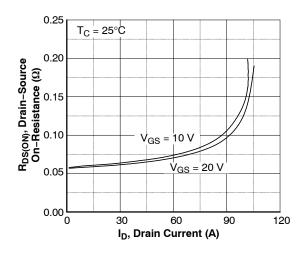
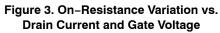


Figure 1. On-Region Characteristics





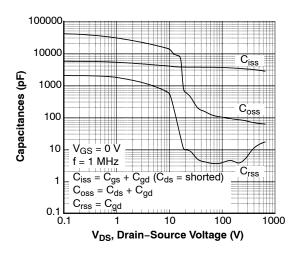


Figure 5. Capacitance Characteristics

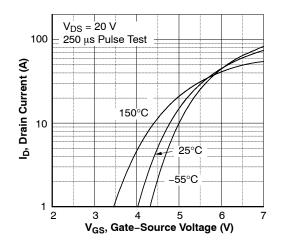
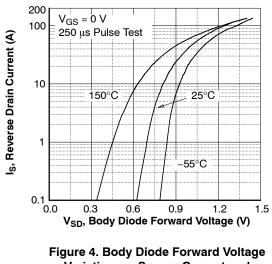


Figure 2. Transfer Characteristics



Variation vs. Source Current and Temperature

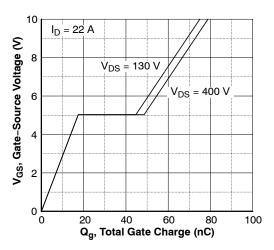
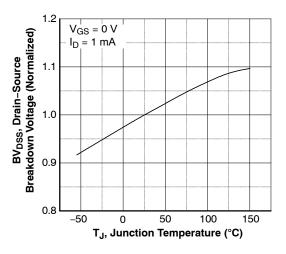
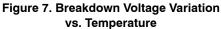


Figure 6. Gate Charge Characteristics



TYPICAL PERFORMANCE CHARACTERISTICS (continued)





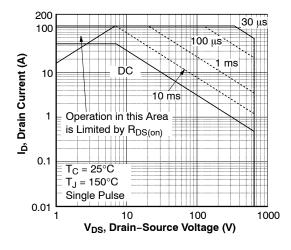


Figure 9. Maximum Safe Operating Area

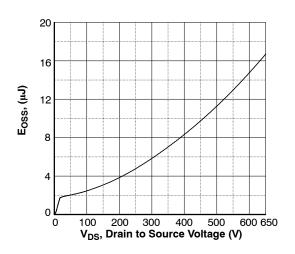


Figure 11. E_{OSS} vs. Drain to Source Voltage

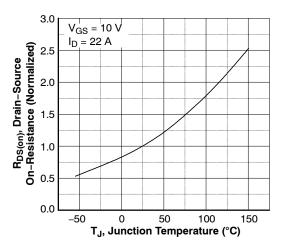


Figure 8. On–Resistance Variation vs. Temperature

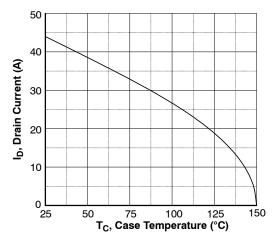


Figure 10. Maximum Drain Current vs. Case Temperature





TYPICAL PERFORMANCE CHARACTERISTICS (continued)

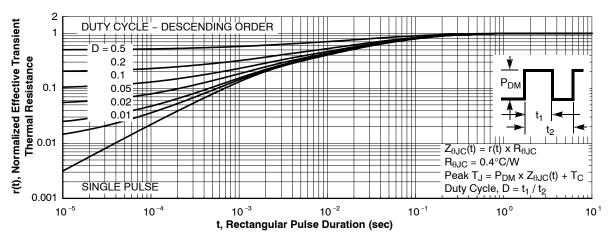
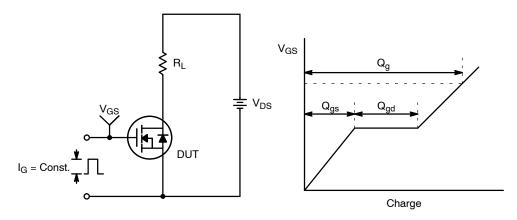


Figure 12. Transient Thermal Response Curve







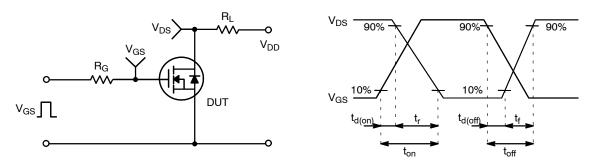


Figure 14. Resistive Switching Test Circuit & Waveforms

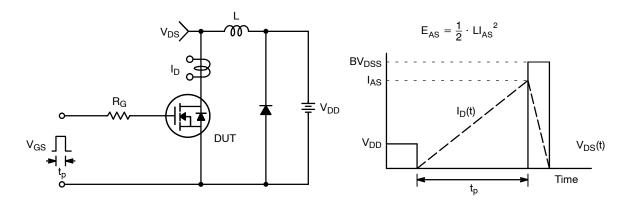


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms



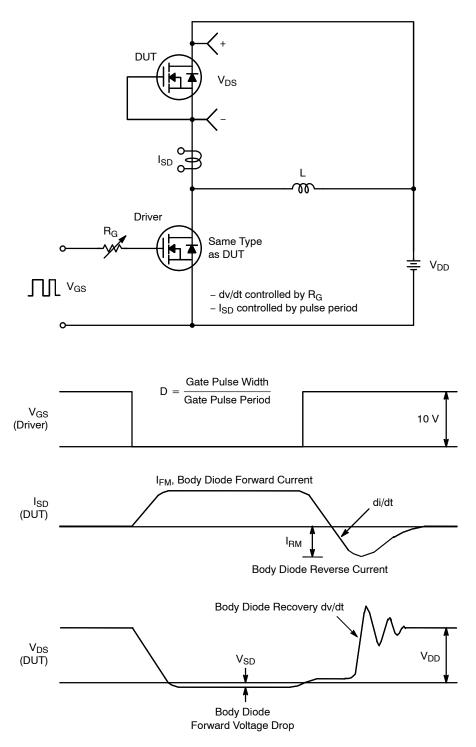


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

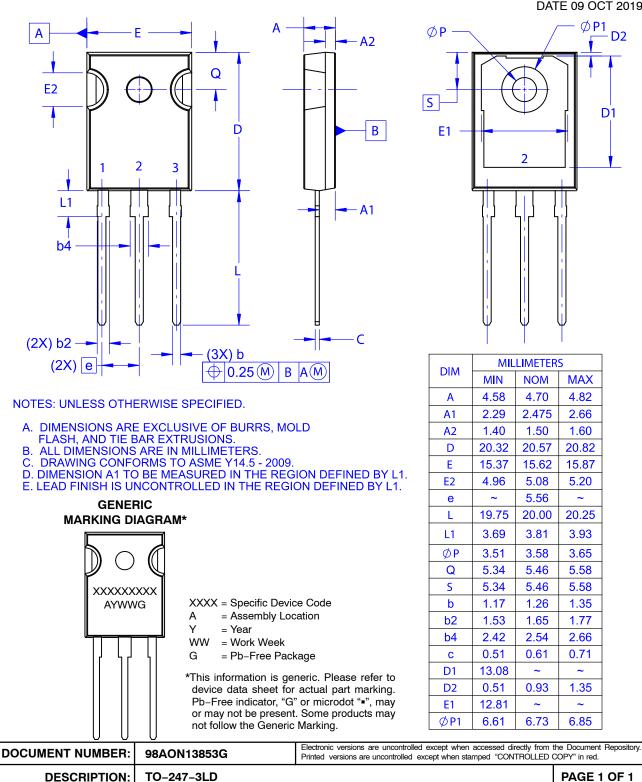
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TO-247-3LD CASE 340CH **ISSUE A**

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